





40V HIGH CURRENT LOW LEAKAGE SCHOTTKY DIODE

Features

- Low Equivalent on Resistance
- Extremely Low Leakage (typically 6µA @30V)
- High current capability (I_F = 1.16A)
- Low V_F, Fast Switching Schottky
- SOT23 Package
- ZLLS1000 Complements Low Temperature Equivalent ZHCS1000
- Package Thermally Rated to +150°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

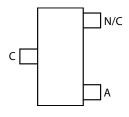
Mechanical Data

- Case: SOT23
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.008 grams (Approximate)

Applications

- DC DC Converters
- Strobes
- Mobile Phones
- Charging Circuits
- Motor Control





Pinout – Top View

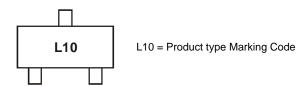
Ordering Information

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZLLS1000TA	L10	7	8	3,000 units
ZLLS1000TC	L10	13	8	10.000 units

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Marking Information







Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

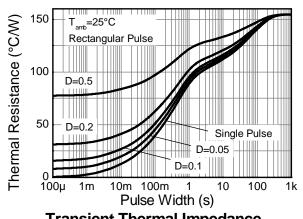
Characteristic		Symbol	Value	Unit
Continuous Reverse Voltage		V _R	40	V
Forward Current		I _F	1.16	A
Peak Repetitive Forward Current Rectangular Pulse Duty Cycle 50% 100µs pulse width		I _{FPK}	2.6	А
Non Repetitive Forward Current	t≤100µs t≤10ms	I _{FSM}	22 6.4	A A

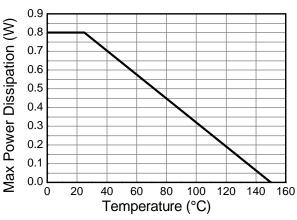
Thermal Characteristics

Charac	Symbol	Value	Unit	
Power Dissipation @T _A = +25°C	Single Die Continuous Single Die Measured at t<5 secs	P _D	0.8 1.18	W
Thermal Resistance Junction to Ambient (Note 4)		$R_{\theta JA}$	155	°C/W
Thermal Resistance Junction to Ambient (Note 5)		$R_{ heta JA}$	106	°C/W
Thermal Resistance Junction to Lead (Solder Point)		$R_{ heta JL}$	80	°C/W
Storage temperature range		T _{STG}	-55 to +150	°C
Junction temperature	T_J	150	°C	

Notes:

Thermal Characteristics and Derating information





Transient Thermal Impedance

Derating Curve

^{4.} For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions. 5. For a device mounted on FRB PCB measured at t<5secs.



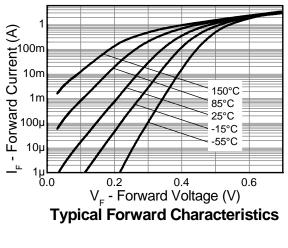


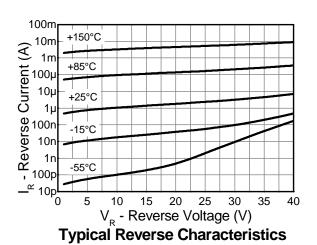
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

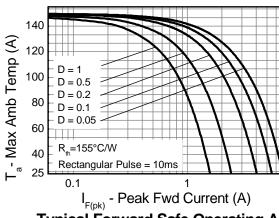
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse breakdown voltage	$V_{(BR)R}$	40	-	-	V	$I_R = 500\mu A$
	VF	-	320	355	mV	$I_F = 50mA$
			335	380		I _F = 100mA
			380	425		I _F = 250mA
Famurand waltage (Nata C)			410	460		I _F = 500mA
Forward voltage (Note 6)			440	510		I _F = 750mA
			470	560		I _F = 1A
			530	660		I _F = 1.5A
			430	-		I _F = 1000mA, T _A = +100°C
Doverno current			5	20	μA	$V_{R} = 30V$
Reverse current	I _R	-	500	-	μA	$V_R = 30V, T_A = +85^{\circ}C$
Diode capacitance	C _D	-	28	-	pF	$f = 1MHz$, $V_R = 30V$
Reverse recovery time Reverse recovery charge	t _{rr} Q _{rr}	-	5 350	-	ns nC	Switched from I _F = 500mA to V _R = 5.5V Measured @ I _R 50mA. di /dt = 500mA/ ns. $R_{source} = 6\Omega$; $R_{load} = 10\Omega$

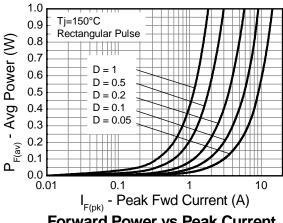
Notes: 6. Measured under pulsed conditions. Pulse width = $300\mu s$. Duty cycle < 2%





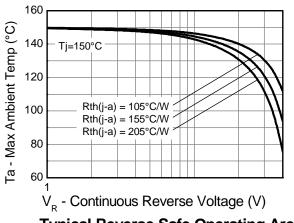


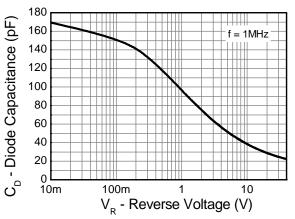




Typical Forward Safe Operating Area

Forward Power vs Peak Current



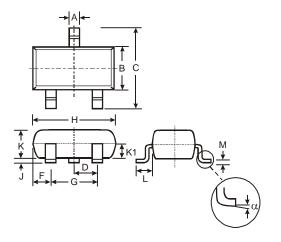


Typical Reverse Safe Operating Area

Capacitance vs Reverse Voltage

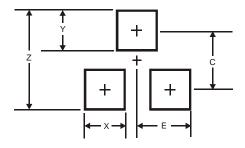


Package Outline Dimensions



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)		
Z	2.9		
Х	8.0		
Υ	0.9		
С	2.0		
E	1.35		





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